

**METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE HAVING
IMPROVED HOT CARRIER IMMUNITY ABILITY**

Appl. No. : 10/711,038 Confirmation No. 5037
Applicant : Wen-Koi Lai,
 Tung-Hsing Lee,
 Tai-Yuan Lee,
 Yu-Lung Chin,
 Yi-Chia Lee,
 Shyh-Fann Ting
Filed : August 19, 2004
TC/A.U. : 2891
Examiner : SMITH, BRADLEY
Docket No. : NAUP0577USA
Customer No. : 27765

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

AMENDMENT

5 Sir:

In response to the Office action of December 15, 2006, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

10 **Remarks/Arguments** begin on page 5 of this paper.